



W1
MECH
SMBUS CBL002

PCB Number: PWR532
PCB Rev: B

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol

PCB
LOGO
FCC disclaimer

LBL1
PCB Label
Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

| Label Table | |
|-------------|-----------------|
| Variant | Label Text |
| 001 | bq28z610EVM-532 |
| 002 | bq78z100EVM-532 |
| | |
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| | |

ZZ2
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ3
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ4
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

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|---|--|--|--|
| Designed for: Public Release | | Mod. Date: 10/5/2015 | |
| Project Title: 1-2s HDQ Li-ion Battery Pack Reference Design | | | |
| Number: PWR532 | | Rev: B | |
| SVN Rev: Version control disabled | | Sheet Title: Assembly Variant: 002 | |
| Drawn By: Ahiakwo, Onyx | | File: PWR532B_Hardware.SchDoc | |
| Engineer: Ahiakwo, Onyx | | Contact: http://www.ti.com/support | |
| Sheet: 2 of 2 | | Size: B | |
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